

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT7095729

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	SECURITY INTEREST
CONVEYING PARTY DATA	
Name	Execution Date
TECHSHOT, INC.	12/28/2021
RECEIVING PARTY DATA	
Name:	ADAMS STREET CREDIT ADVISORS LP
Street Address:	ONE NORTH WACKER DRIVE, SUITE 2700
City:	CHICAGO
State/Country:	ILLINOIS
Postal Code:	60606
PROPERTY NUMBERS Total: 11	
Property Type	Number
Application Number:	16517106
Application Number:	16926039
Application Number:	17107142
Application Number:	10270977
Application Number:	15225547
Application Number:	15882039
Application Number:	10003481
Application Number:	14144446
Application Number:	13443494
Application Number:	15178672
Application Number:	13174124
CORRESPONDENCE DATA	
Fax Number:	(800)494-7512
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	2023704750
Email:	ipteam@cogencyglobal.com
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Address Line 2:	COGENCY GLOBAL INC.
Address Line 4:	WASHINGTON, D.C. 20036

PATENT

ATTORNEY DOCKET NUMBER:	(98563.00005)/1558103
NAME OF SUBMITTER:	YOOSON SANDY LEE
SIGNATURE:	/s/ YOOSON SANDY LEE
DATE SIGNED:	12/28/2021
Total Attachments: 6 source=Redwire - Patent Security Agreement [Techshot] [executed]_(82528672_1)#page1.tif source=Redwire - Patent Security Agreement [Techshot] [executed]_(82528672_1)#page2.tif source=Redwire - Patent Security Agreement [Techshot] [executed]_(82528672_1)#page3.tif source=Redwire - Patent Security Agreement [Techshot] [executed]_(82528672_1)#page4.tif source=Redwire - Patent Security Agreement [Techshot] [executed]_(82528672_1)#page5.tif source=Redwire - Patent Security Agreement [Techshot] [executed]_(82528672_1)#page6.tif	

PATENT SECURITY AGREEMENT

This **PATENT SECURITY AGREEMENT**, dated as of December 28, 2021 (as amended, restated, amended and restated, supplemented or otherwise modified from time to time, this “**Patent Security Agreement**”), is made by TECHSHOT, INC., an Indiana corporation (the “**Grantor**”), in favor of Adams Street Credit Advisors LP, as Collateral Agent for the Secured Parties (in such capacity and together with its successors and permitted assigns, the “**Collateral Agent**”).

WHEREAS, the Grantor is party to that certain Security Agreement Supplement (the “**Supplement**”), dated as of the date hereof, between the Grantor and the Collateral Agent for the Secured Parties, which supplements that certain Security Agreement, dated as of October 28, 2020 (as supplemented by the Supplement and as further amended, restated, amended and restated, supplemented or otherwise modified from time to time, the “**Security Agreement**”) between each of the grantors party thereto and the Collateral Agent, pursuant to which the Grantor granted a security interest to the Collateral Agent (on behalf of the Secured Parties) in the Patent Collateral (as defined below) and are required to execute and deliver this Patent Security Agreement.

NOW, THEREFORE, in consideration of the foregoing and for other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, the Grantor hereby agrees with the Collateral Agent as follows:

SECTION 1. DEFINED TERMS

Unless otherwise defined herein, terms defined in the Security Agreement and used herein have the respective meaning given to them in the Security Agreement.

SECTION 2. GRANT OF SECURITY INTEREST

As collateral security for the payment or performance in full of the Secured Obligations, including the Guaranteed Obligations, the Grantor hereby pledges to the Collateral Agent, its successors and permitted assigns, for the benefit of the Secured Parties, and hereby grants to the Collateral Agent, its successors and permitted assigns, for the benefit of the Secured Parties, a security interest in all right, title or interest in or to any and all of the following assets and properties constituting Collateral that are now owned or at any time hereafter acquired by the Grantor or in which the Grantor now has or at any time in the future may acquire any right, title or interest (collectively, the “**Patent Collateral**”); *provided* that, the Patent Collateral shall not include any Excluded Assets:

- (a) all letters patent of the United States in or to which the Grantor now or hereafter owns any right, title or interest therein, all registrations and recordings thereof, and all applications for letters patent of the United States, including registrations, recordings and pending applications in the USPTO, including any of the foregoing listed in Schedule A hereto, and (b) all reissues, continuations, divisionals, continuations-in-part, renewals, improvements or extensions thereof, and the inventions or designs disclosed or claimed therein, including the right to make, use and/or sell the inventions or designs disclosed or claimed therein,

(b) all additions and improvements to the foregoing, renewals and extensions thereof, rights to sue or otherwise recover for infringements or other violations thereof,

(c) all rights corresponding to the foregoing throughout the world, and

(d) to the extent not otherwise included, all Proceeds, products, accessions, rents and profits of any and all of the foregoing.

SECTION 3. SECURITY AGREEMENT

The security interest granted pursuant to this Patent Security Agreement is granted in conjunction with the security interest granted to the Collateral Agent for the Secured Parties pursuant to the Security Agreement, and the Grantor hereby acknowledges and affirms that the rights and remedies of the Collateral Agent with respect to the security interest in the Patent Collateral made and granted hereby are more fully set forth in the Security Agreement, the terms and provisions of which are incorporated by reference herein as if fully set forth herein. In the event that any provision of this Patent Security Agreement is deemed to conflict with the Security Agreement, the provisions of the Security Agreement shall control.

SECTION 4. RECORDATION

The Grantor hereby authorizes and requests that the USPTO record this Patent Security Agreement.

SECTION 5. TERMINATION

This Patent Security Agreement shall terminate and the security interest in the Patent Collateral shall be released upon the payment and performance of the Secured Obligations (other than any outstanding indemnification obligations). Upon the termination of this Patent Security Agreement, the Collateral Agent shall execute all documents, make all filings and take all other actions reasonably requested by the Grantor to evidence and record the release of the security interests in the Patent Collateral granted herein.

SECTION 6. GOVERNING LAW

THIS PATENT SECURITY AGREEMENT SHALL BE GOVERNED BY, AND CONSTRUED IN ACCORDANCE WITH, THE LAW OF THE STATE OF NEW YORK.

SECTION 7. COUNTERPARTS


This Patent Security Agreement may be executed in one or more counterparts and by different parties hereto in separate counterparts, each of which when so executed and delivered shall be deemed an original, but all such counterparts together shall constitute but one and the same instrument. Delivery by facsimile or other electronic communication of an executed counterpart of a signature page to this Patent Security Agreement shall be effective as delivery of an original executed counterpart of this Patent Security Agreement.

[Remainder of page intentionally left blank]

IN WITNESS WHEREOF, the Grantor has caused this Patent Security Agreement to be executed and delivered by its duly authorized officer as of the date first set forth above.

GRANTOR:

TECHSHOT, INC.

By:  _____

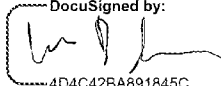
Name: William Read

Title: Chief Financial Officer

ADAMS STREET CREDIT ADVISORS LP,
as Collateral Agent

By: Adams Street Credit Advisors GP LLC
its general partner

By: Adams Street Partners, LLC, its member

By: 
Name: William B. Sacher
Title: Partner

SCHEDULE A
to
PATENT SECURITY AGREEMENT

PATENTS AND PATENT APPLICATIONS

Title	Country	Application No.	Application Date	Registration No.	Registration Date	Status	Owner
Biomanufacturing System, Method, and 3D Bioprinting Hardware in a Reduced Gravity Environment	USA	165177106	2019-07-19	--	--	Pending	Techshot, Inc.
Biomanufacturing System, Method, and 3D Bioprinting Hardware in a Reduced Gravity Environment	USA	16926039	2020-07-10	--	--	Pending	Techshot, Inc.
Biomanufacturing System, Method, and 3D Bioprinting Hardware in a Reduced Gravity Environment	USA	17107142	2020-11-30	--	--	Pending	Techshot, Inc.
Apparatus and method for centrifugation and robotic manipulation of samples: For robotically incubating eggs or other entities under various conditions of inertial acceleration, and, more particularly, for incubating vertebrate eggs in a controlled environment in which centrifugation is provided as a source of inertial acceleration, for experiments performed on orbiting spacecraft	USA	10270977	2002-10-15	7261860	2007-08-28	Granted	Techshot, Inc.
Biomanufacturing system, method, and 3D bioprinting hardware in a reduced gravity environment	USA	15225547	2016-08-01	10655096	2020-05-19	Granted	Techshot, Inc.
Biomanufacturing system, method, and 3D bioprinting hardware in a reduced gravity environment	USA	15882039	2018-01-29	10851333	2020-12-01	Granted	Techshot, Inc.

Title	Country	Application No.	Application Date	Registration No.	Registration Date	Status	Owner
Bioreactor apparatus and cell culturing system: Bioreactor apparatus and cell culturing system for use in the propagation of preferential cells	USA	10003481	2001-10-25	7198940	2007-04-03	Granted	Techshot, Inc.
Cell processing cartridge for miniature cytometer	USA	14144446	2013-12-30	9753026	2017-09-05	Granted	Techshot, Inc.
Distwashing system	USA	13443494	2012-04-10	9144365	2015-09-29	Granted	Techshot, Inc.
Integrated illuminator and condenser for microscopes	USA	15178672	2016-06-10	10502942	2019-12-10	Granted	Techshot, Inc.
Method for non-invasive determination of chemical properties of aqueous solutions	USA	13174124	2011-06-30	9372157	2016-06-21	Granted	Techshot, Inc.

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REEL: 058492 FRAME: 0301

RECORDED: 12/28/2021